



IPW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

the application of

: Confirmation No. 8585

Akihiro YAMAMOTO et al.

: Docket No. 2003\_0945A

Serial No. 10/614,784

: Group Art Unit 1734

Filed July 9, 2003

: Examiner G. Koch

METHOD AND APPARATUS FOR  
DETERMINING PROCESSING SIZE  
OF BONDING MATERIAL

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AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEES FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975

Sir:

In response to the Office Action of May 5, 2004, please amend the above-identified U.S. Patent application as follows: